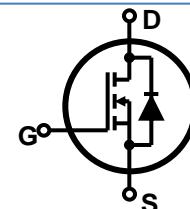


Features

- Low gate charge
- 100% avalanche tested
- Improved dv/dt capability
- RoHS compliant
- Halogen free package
- JEDEC Qualification
- Fast reverse recovery

$V_{DSS} = 550 \text{ V} @ T_{jmax}$
 $I_D = 4.5 \text{ A}$
 $R_{DS(ON)} = 1.65 \text{ (max)} @ V_{GS}= 10 \text{ V}$



| Device | Package | Marking | Remark |
|-----------------|-------------|---------|--------|
| TMD5N50/TMU5N50 | D-PAK/I-PAK | | |
| | | | |

Absolute Maximum Ratings

| Parameter | Symbol | TMD5N50(G)/TMU5N50(G) | Unit |
|--|----------------|-----------------------|------|
| Drain-Source Voltage | V_{DSS} | 500 | V |
| Gate-Source Voltage | V_{GS} | ± 30 | V |
| Continuous Drain Current $T_C = 25 \text{ }^\circ\text{C}$ | I_D | 4.5 | A |
| | | 2.86 | A |
| Pulsed Drain Current (Note 1) | I_{DM} | 18 | A |
| Single Pulse Avalanche Energy (Note 2) | E_{AS} | 240 | mJ |
| Repetitive Avalanche Current (Note 1) | I_{AR} | 4.5 | A |
| Repetitive Avalanche Energy (Note 1) | E_{AR} | 9.25 | mJ |
| Power Dissipation $T_C = 25 \text{ }^\circ\text{C}$ | P_D | 92.5 | W |
| | | 0.74 | W/°C |
| Peak Diode Recovery dv/dt (Note 3) | dv/dt | 4.5 | V/ns |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55~150 | °C |
| Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds | T_L | 300 | °C |

* Limited only by maximum junction temperature

Thermal Characteristics

| Parameter | Symbol | TMD5N50(G)/TMU5N50(G) | Unit |
|---|----------|-----------------------|------|
| Maximum Thermal resistance, Junction-to-Case | R_{JC} | 1.35 | °C/W |
| Maximum Thermal resistance, Junction-to-Ambient | R_{JA} | 62.5 | °C/W |

Electrical Characteristics : $T_c=25^\circ\text{C}$, unless otherwise noted

| Parameter | Symbol | Test condition | Min | Typ | Max | Units |
|---|--------------------------|---|-----|------|------|---------------|
| OFF | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{\text{GS}} = 0 \text{ V}, I_{\text{D}} = 250 \mu\text{A}$ | 500 | -- | -- | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{\text{DS}} = 500 \text{ V}, V_{\text{GS}} = 0 \text{ V}$ | -- | -- | 1 | μA |
| | | $V_{\text{DS}} = 400 \text{ V}, T_c = 125^\circ\text{C}$ | -- | -- | 10 | μA |
| Forward Gate-Source Leakage Current | I_{GSSF} | $V_{\text{GS}} = 30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$ | -- | -- | 100 | nA |
| Reverse Gate-Source Leakage Current | I_{GSSR} | $V_{\text{GS}} = -30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$ | -- | -- | -100 | nA |
| ON | | | | | | |
| Gate Threshold Voltage | $V_{\text{GS(th)}}$ | $V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250 \mu\text{A}$ | 2.0 | -- | 4.0 | V |
| Drain-Source On-Resistance | $R_{\text{DS(on)}}$ | $V_{\text{GS}} = 10 \text{ V}, I_{\text{D}} = 2.25 \text{ A}$ | -- | 1.4 | 1.65 | |
| Forward Transconductance ^(Note 4) | g_{FS} | $V_{\text{DS}} = 30 \text{ V}, I_{\text{D}} = 2.25 \text{ A}$ | -- | 6 | -- | S |
| DYNAMIC | | | | | | |
| Input Capacitance | C_{iss} | $V_{\text{DS}} = 25 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1.0 \text{ MHz}$ | -- | 627 | -- | pF |
| Output Capacitance | C_{oss} | | -- | 61 | -- | pF |
| Reverse Transfer Capacitance | C_{rss} | | -- | 4.4 | -- | pF |
| SWITCHING | | | | | | |
| Turn-On Delay Time ^(Note 4,5) | $t_{\text{d(on)}}$ | $V_{\text{DD}} = 250 \text{ V}, I_{\text{D}} = 4.5 \text{ A}, R_G = 25$ | -- | 42 | -- | ns |
| Turn-On Rise Time ^(Note 4,5) | t_r | | -- | 32 | -- | ns |
| Turn-Off Delay Time ^(Note 4,5) | $t_{\text{d(off)}}$ | | -- | 68 | -- | ns |
| Turn-Off Fall Time ^(Note 4,5) | t_f | | -- | 30 | -- | ns |
| Total Gate Charge ^(Note 4,5) | Q_g | $V_{\text{DS}} = 400 \text{ V}, I_{\text{D}} = 4.5 \text{ A}, V_{\text{GS}} = 10 \text{ V}$ | -- | 11 | -- | nC |
| Gate-Source Charge ^(Note 4,5) | Q_{gs} | | -- | 3.2 | -- | nC |
| Gate-Drain Charge ^(Note 4,5) | Q_{gd} | | -- | 2.7 | -- | nC |
| SOURCE DRAIN DIODE | | | | | | |
| Maximum Continuous Drain-Source Diode Forward Current | I_S | ---- | -- | -- | 4.5 | A |
| Maximum Pulsed Drain-Source Diode Forward Current | I_{SM} | ---- | -- | -- | 18 | A |
| Drain-Source Diode Forward Voltage | V_{SD} | $V_{\text{GS}} = 0 \text{ V}, I_S = 4.5 \text{ A}$ | -- | -- | 1.5 | V |
| Reverse Recovery Time ^(Note 4) | t_{rr} | $V_{\text{GS}} = 0 \text{ V}, I_S = 4.5 \text{ A}$ $dI_F / dt = 100 \text{ A}/\mu\text{s}$ | -- | 255 | -- | ns |
| Reverse Recovery Charge ^(Note 4) | Q_{rr} | | -- | 1.43 | -- | μC |

Note :

1. Repeated rating : Pulse width limited by safe operating area
2. $L=21\text{mH}$, $I_{AS} = 4.5\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25$, Starting $T_J = 25^\circ\text{C}$
- 3 $I_{SD} = 4.5\text{A}$, $dI/dt = 200\text{A}/\mu\text{s}$, $V_{DD} = BV_{DS}$, Starting $T_J = 25^\circ\text{C}$
4. Pulse Test :Pulse width 300 μs , Duty Cycle 2%
5. Essentially Independent of Operating Temperature Typical Characteristics

